

PRODUCT FEATURES

- High short circuit capability, self limiting short circuit current
- IGBT CHIP(T4 Fast Trench+Field Stop technology)
- $V_{CE(sat)}$ with positive temperature coefficient
- Fast switching and short tail current
- Free wheeling diodes with fast and soft reverse recovery
- Low switching losses
- $T_{Jmax} = 175^\circ\text{C}$



APPLICATIONS

- High frequency switching application
- Medical applications
- Motion/servo control
- UPS systems

IGBT-inverter

ABSOLUTE MAXIMUM RATINGS ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Values	Unit
V_{CES}	Collector Emitter Voltage	$T_J=25^\circ\text{C}$	1200	V
V_{GES}	Gate Emitter Voltage		± 20	
I_C	DC Collector Current	$T_C=25^\circ\text{C}, T_{Jmax}=175^\circ\text{C}$	300	A
		$T_C=95^\circ\text{C}, T_{Jmax}=175^\circ\text{C}$	200	
I_{CM}	Repetitive Peak Collector Current	$t_p=1\text{ms}$	400	
P_{tot}	Power Dissipation Per IGBT	$T_C=25^\circ\text{C}, T_{Jmax}=175^\circ\text{C}$	1150	W

Diode-inverter

ABSOLUTE MAXIMUM RATINGS ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Values	Unit
V_{RRM}	Repetitive Reverse Voltage	$T_J=25^\circ\text{C}$	1200	V
$I_{F(AV)}$	Average Forward Current		200	
I_{FRM}	Repetitive Peak Forward Current	$t_p=1\text{ms}$	400	A
I^2t		$T_J=125^\circ\text{C}, t=10\text{ms}, V_R=0\text{V}$	7750	

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MMG200D120B6HN

IGBT-inverter

ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit
$V_{GE(\text{th})}$	Gate Emitter Threshold Voltage	$V_{CE}=V_{GE}$, $I_C=8\text{mA}$	5.4	6.0	6.5	V
$V_{CE(\text{sat})}$	Collector Emitter Saturation Voltage	$I_C=200\text{A}$, $V_{GE}=15\text{V}$, $T_J=25^\circ\text{C}$		2.1	2.5	
		$I_C=200\text{A}$, $V_{GE}=15\text{V}$, $T_J=125^\circ\text{C}$		2.5		
I_{CES}	Collector Leakage Current	$V_{CE}=1200\text{V}$, $V_{GE}=0\text{V}$, $T_J=25^\circ\text{C}$			1	mA
		$V_{CE}=1200\text{V}$, $V_{GE}=0\text{V}$, $T_J=125^\circ\text{C}$			10	
I_{GES}	Gate Leakage Current	$V_{CE}=0\text{V}$, $V_{GE}=\pm 15\text{V}$, $T_J=25^\circ\text{C}$	-400		400	nA
R_{gint}	Integrated Gate Resistor			3.8		Ω
Q_g	Gate Charge	$V_{CE}=600\text{V}$, $I_C=200\text{A}$, $V_{GE}=15\text{V}$		0.95		μC
C_{ies}	Input Capacitance	$V_{CE}=25\text{V}$, $V_{GE}=0\text{V}$, $f=1\text{MHz}$		12.5		nF
C_{res}	Reverse Transfer Capacitance			700		pF
$t_{d(on)}$	Turn on Delay Time	$V_{CC}=600\text{V}$, $I_C=200\text{A}$, $R_G=3.6\Omega$, $V_{GE}=\pm 15\text{V}$, Inductive Load	$T_J=25^\circ\text{C}$		160	ns
			$T_J=125^\circ\text{C}$		170	ns
			$T_J=150^\circ\text{C}$		180	ns
t_r	Rise Time	$V_{CC}=600\text{V}$, $I_C=200\text{A}$, $R_G=3.6\Omega$, $V_{GE}=\pm 15\text{V}$, Inductive Load	$T_J=25^\circ\text{C}$		70	ns
			$T_J=125^\circ\text{C}$		80	ns
			$T_J=150^\circ\text{C}$		85	ns
$t_{d(off)}$	Turn off Delay Time	$V_{CC}=600\text{V}$, $I_C=200\text{A}$, $R_G=3.6\Omega$, $V_{GE}=\pm 15\text{V}$, Inductive Load	$T_J=25^\circ\text{C}$		420	ns
			$T_J=125^\circ\text{C}$		470	ns
			$T_J=150^\circ\text{C}$		500	ns
t_f	Fall Time	$V_{CC}=600\text{V}$, $I_C=200\text{A}$, $R_G=3.6\Omega$, $V_{GE}=\pm 15\text{V}$, Inductive Load	$T_J=25^\circ\text{C}$		40	ns
			$T_J=125^\circ\text{C}$		60	ns
			$T_J=150^\circ\text{C}$		70	ns
E_{on}	Turn on Energy	$V_{CC}=600\text{V}$, $I_C=200\text{A}$, $R_G=3.6\Omega$, $V_{GE}=\pm 15\text{V}$, Inductive Load	$T_J=125^\circ\text{C}$		18.5	mJ
E_{off}	Turn off Energy		$T_J=150^\circ\text{C}$		20.5	mJ
I_{sc}	Short Circuit Current	$tpsc \leq 10\mu\text{s}$, $V_{GE}=15\text{V}$, $T_J=125^\circ\text{C}$, $V_{CC}=600\text{V}$			800	A
R_{thJC}	Junction to Case Thermal Resistance (Per IGBT)				0.13	K /W

Diode-inverter

ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit
V_F	Forward Voltage	$I_F=200\text{A}$, $V_{GE}=0\text{V}$, $T_J=25^\circ\text{C}$		1.65	2.15	V
		$I_F=200\text{A}$, $V_{GE}=0\text{V}$, $T_J=125^\circ\text{C}$		1.65		
t_{rr}	Reverse Recovery Time			400		ns
I_{RRM}	Max. Reverse Recovery Current	$I_F=200\text{A}$, $V_R=600\text{V}$, $dI_F/dt=-2500\text{A}/\mu\text{s}$, $T_J=125^\circ\text{C}$		180		A
Q_{RR}	Reverse Recovery Charge			38.8		μC
E_{rec}	Reverse Recovery Energy			15.5		mJ
R_{thJCD}	Junction to Case Thermal Resistance (Per Diode)				0.25	K /W

MMG200D120B6HN

MODULE CHARACTERISTICS ($T_c=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions	Values	Unit
$T_{J\max}$	Max. Junction Temperature	175	$^\circ\text{C}$
T_{Jop}	Operating Temperature	-40~150	
T_{stg}	Storage Temperature	-40~125	
V_{isol}	Isolation Breakdown Voltage	AC, 50Hz(R.M.S), t=1minute	V
CTI	Comparative Tracking Index	> 225	
Torque	to heatsink	Recommended (M6)	Nm
	to terminal	Recommended (M6)	Nm
Weight		300	g

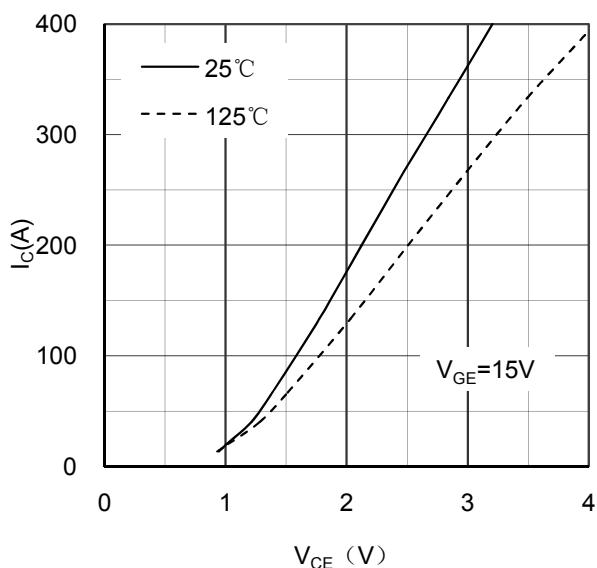


Figure 1. Typical Output Characteristics IGBT-inverter

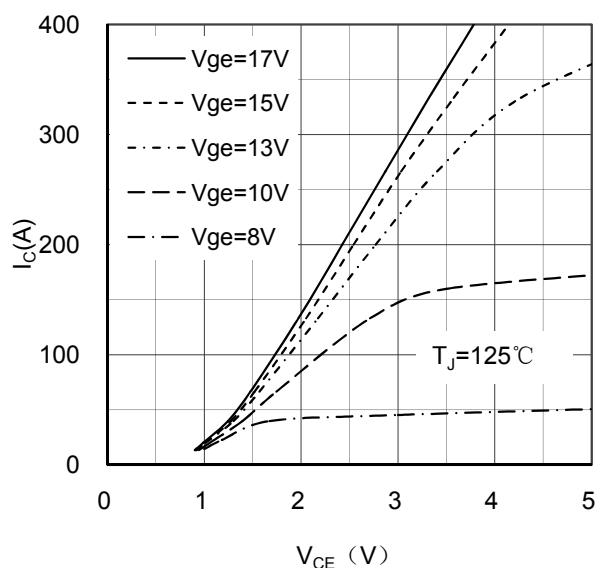


Figure 2. Typical Output Characteristics IGBT-inverter

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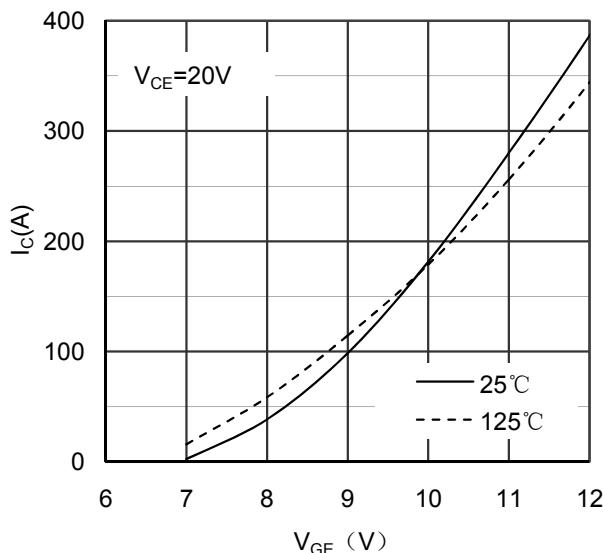


Figure 3. Typical Transfer characteristics IGBT-inverter

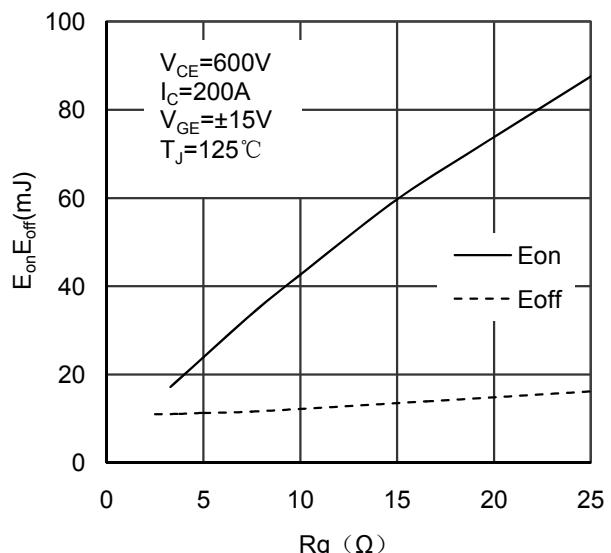


Figure 4. Switching Energy vs Gate Resistor IGBT-inverter

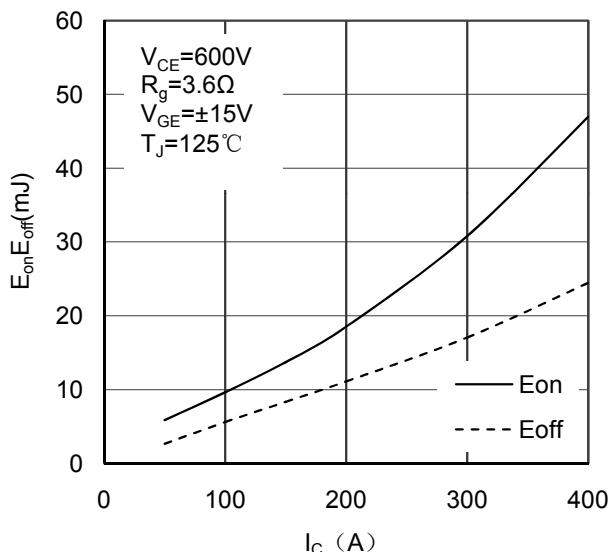


Figure 5. Switching Energy vs Collector Current IGBT-inverter

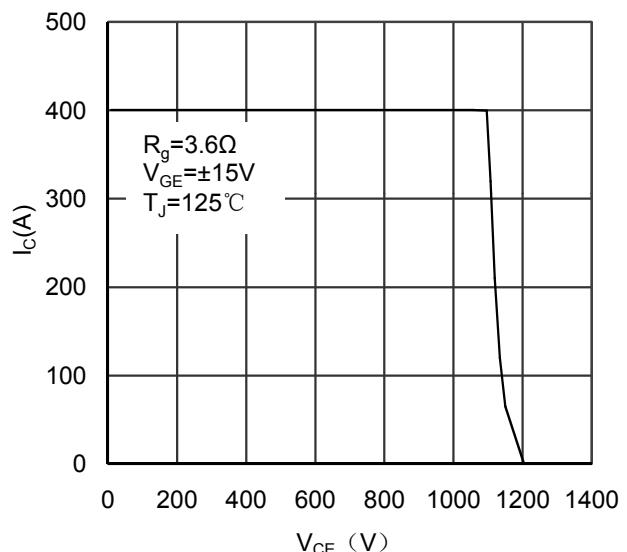


Figure 6. Reverse Biased Safe Operating Area IGBT-inverter

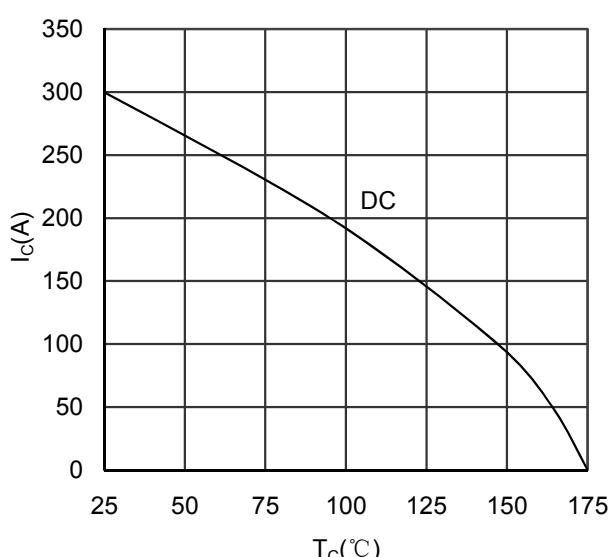


Figure 7. Collector Current vs Case temperature IGBT -inverter

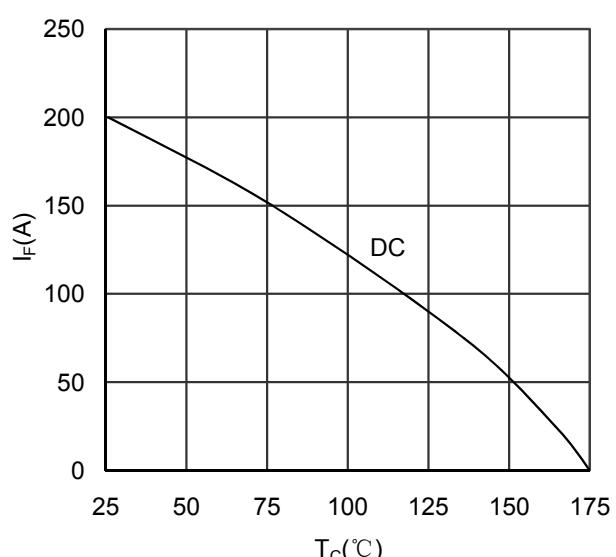


Figure 8. Forward current vs Case temperature Diode -inverter

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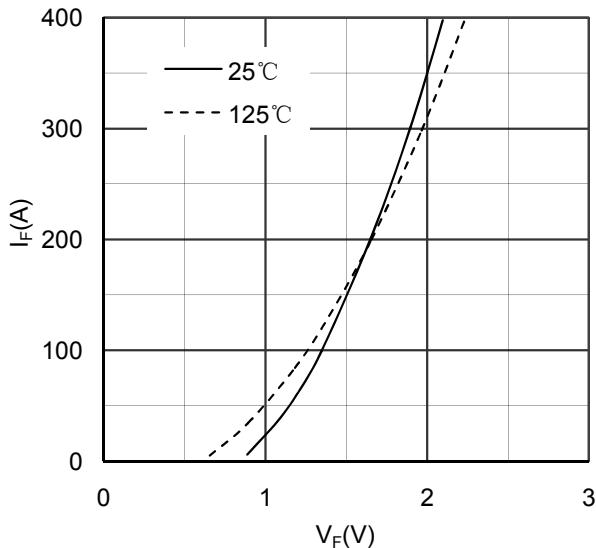


Figure 9. Diode Forward Characteristics Diode-inverter

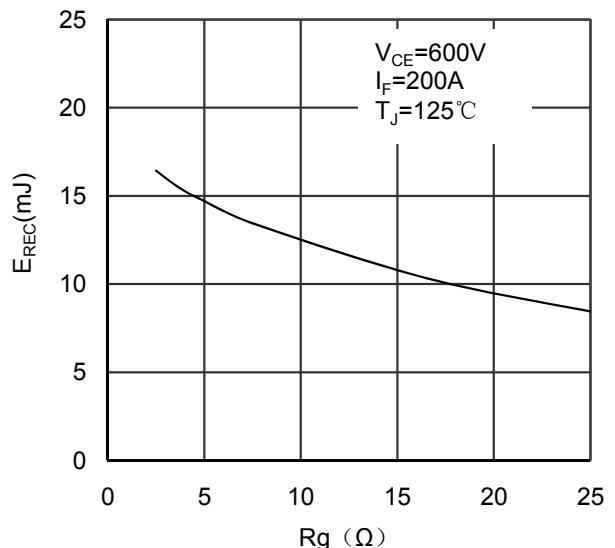


Figure 10. Switching Energy vs Gate Resistor Diode - inverter

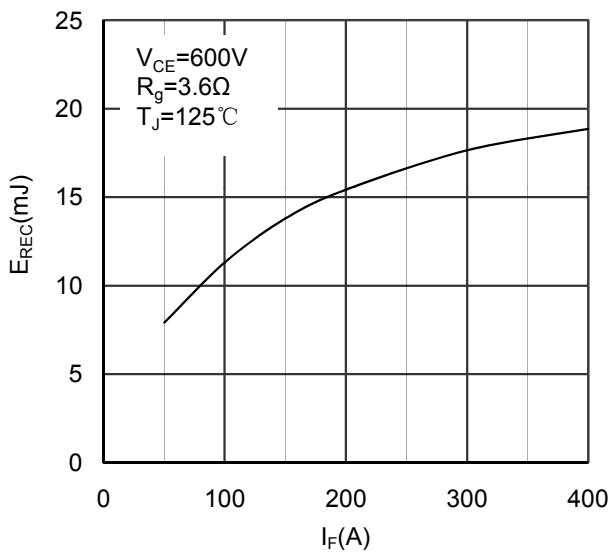


Figure 11. Switching Energy vs Forward Current Diode-inverter

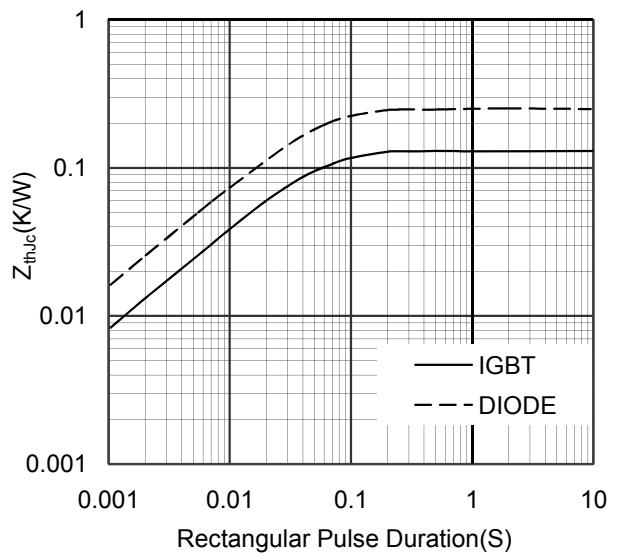


Figure 12. Transient Thermal Impedance of Diode-inverter and IGBT-inverter

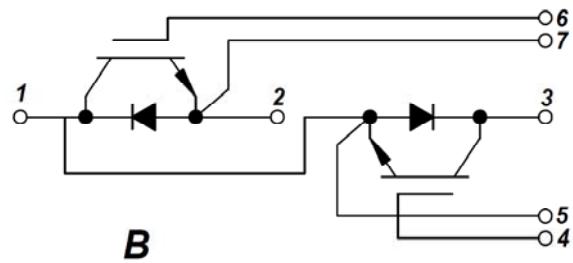
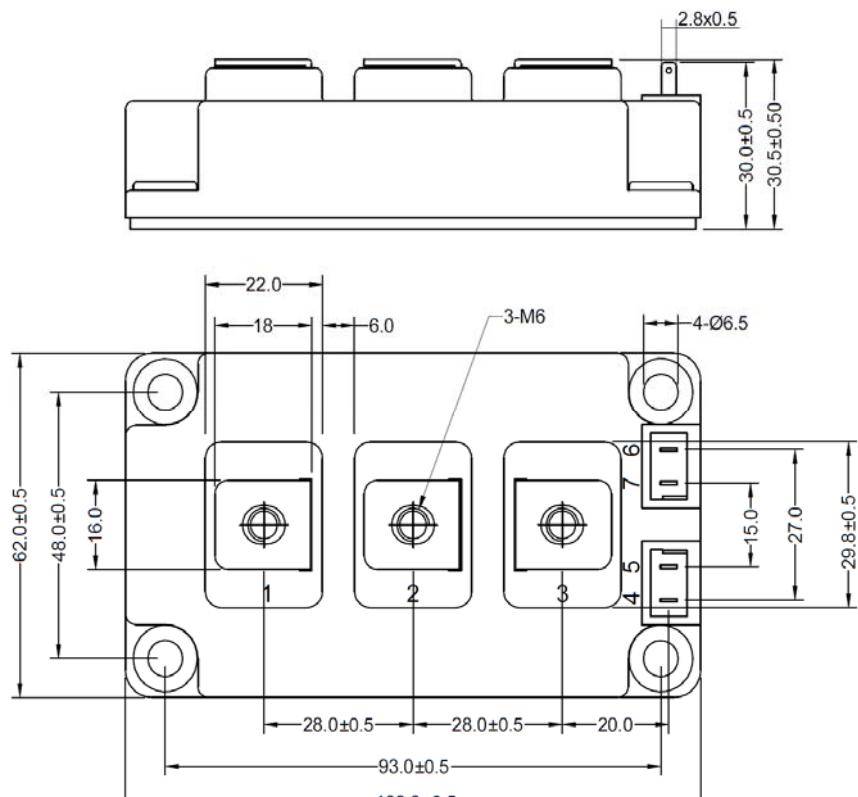


Figure 13. Circuit Diagram



Dimensions in (mm)
Figure 14. Package Outline